# Silicon N-Channel Dual Gate MOS FET

# HITACHI

ADE-208-271 1st. Edition

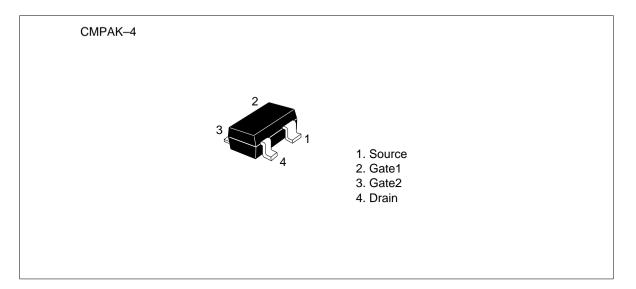
### Application

UHF RF amplifier

#### Features

- Low noise figure. NF = 2.3 dB Typ. at f = 900 MHz
- High gain. PG = 19.3 dB Typ. at f = 900 MHz

# Outline





# **Absolute Maximum Ratings** (Ta = 25°C)

Item	Symbol	Ratings	Unit	
Drain to source voltage	V <sub>DS</sub>	12	V	
Gate 1 to source voltage	V <sub>G1S</sub>	±8	V	
Gate 2 to source voltage	$V_{G2S}$	±8	V	
Drain current	Ι <sub>D</sub>	25	mA	
Channel power dissipation	Pch	100	mW	
Channel temperature	Tch	125	°C	
Storage temperature	Tstg	-55 to +125	°C	

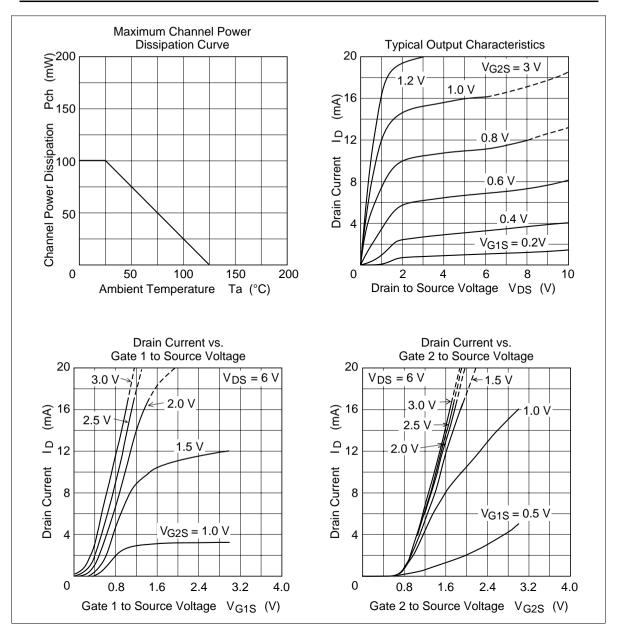
Attention: This device is very sensitive to electro static discharge.

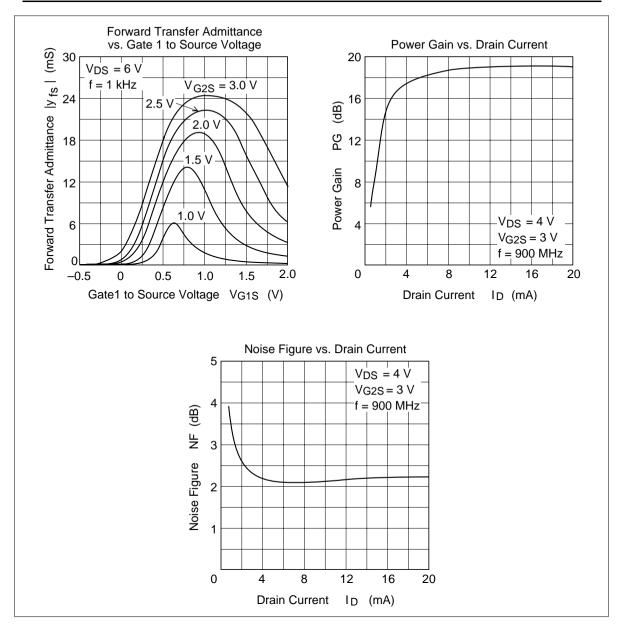
It is recommended to adopt appropriate cautions when handling this transistor.

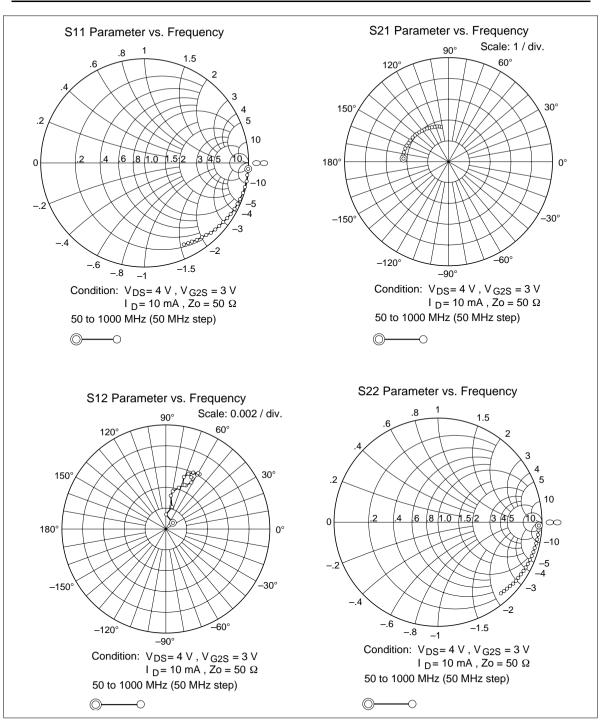
# **Electrical Characteristics** (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSX}}$	12	_	_	V	$I_{\rm D}$ = 200 µA, $V_{\rm G1S}$ = -3 V, $V_{\rm G2S}$ = -3 V
Gate 1 to source breakdown voltage	$V_{\rm (BR)G1SS}$	±8	_	_	V	$I_{G1} = \pm 10 \ \mu A, \ V_{G2S} = V_{DS} = 0$
Gate 2 to source breakdown voltage	$V_{(BR)G2SS}$	±8	_	_	V	$I_{G2} = \pm 10 \ \mu A, \ V_{G1S} = V_{DS} = 0$
Gate 1 cutoff current	I <sub>G1SS</sub>	—	_	±100	nA	$V_{G1S} = \pm 6 V, V_{G2S} = V_{DS} = 0$
Gate 2 cutoff current	I <sub>G2SS</sub>	—	—	±100	nA	$V_{G2S} = \pm 6 V, V_{G1S} = V_{DS} = 0$
Drain current	I <sub>DS(on)</sub>	0.5	_	10	mA	$V_{\text{DS}} = 6 \text{ V}, V_{\text{G1S}} = 0.5 \text{ V}, V_{\text{G2S}} = 3 \text{ V}$
Gate 1 to source cutoff voltage	$V_{\text{G1S(off)}}$	-0.6	_	+0.5	V	$V_{\rm DS}$ = 10 V, $V_{\rm G2S}$ = 3 V, I <sub>D</sub> = 100 µA
Gate 2 to source cutoff voltage	$V_{\text{G2S(off)}}$	0	_	+1.0	V	$V_{DS} = 10 \text{ V}, \text{ V}_{G1S} = 3 \text{ V},$ $I_{D} = 100 \mu\text{A}$
Forward transfer admittance	y <sub>fs</sub>	16	22	_	mS	$V_{DS} = 6 V, V_{G2S} = 3 V,$ $I_{D} = 10 mA, f = 1 kHz$
Input capacitance	Ciss	1.2	1.8	2.2	pF	$V_{DS} = 6 V, V_{G2S} = 3V,$ $I_{D} = 10 mA, f = 1 MHz$
Output capacitance	Coss	0.7	1.2	1.4	pF	_
Reverse transfer capacitance	Crss	_	0.02	0.03	pF	
Power gain	PG	17	19.3	_	dB	$V_{DS} = 4 V, V_{G2S} = 3 V,$ $I_{D} = 10 mA, f = 900 MHz$
Noise figure	NF	_	2.3	2.8	dB	

Note: Marking is "ZJ-".



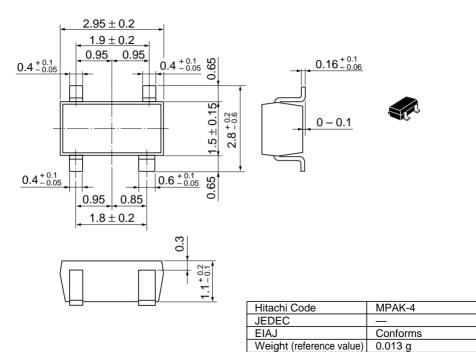




<b>S</b> Parameter	$(V_{DS} = 4 V,$	$V_{G2S} = 3 V$	$I_{\rm D} = 10 \text{ mA}$	$, Z_0 = 50 \Omega)$
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Freq.	S11		S21		S12		S22	
(MHz)	MAG.	ANG.	MAG.	ANG.	MAG.	ANG.	MAG.	ANG.
50	0.998	-3.3	2.17	176	0.001	41.3	0.971	-1.9
100	0.994	-6.7	2.20	172	0.001	88.9	0.971	-4.5
150	0.997	-10.2	2.19	168	0.002	74.4	0.970	-7.1
200	0.991	-13.5	2.17	163	0.003	81.6	0.969	-9.8
250	0.993	-16.9	2.16	159	0.004	79.7	0.967	-12.1
300	0.980	-20.8	2.12	155	0.004	72.6	0.965	-14.8
350	0.976	-23.7	2.10	151	0.005	66.9	0.962	-17.3
400	0.971	-27.0	2.08	146	0.005	70.9	0.959	-19.7
450	0.962	-30.7	2.05	142	0.006	67.7	0.956	-22.1
500	0.955	-33.7	2.03	139	0.006	63.9	0.953	-24.8
550	0.945	-36.9	1.99	135	0.006	64.1	0.950	-27.2
600	0.939	-40.2	1.96	131	0.006	63.9	0.946	-29.5
650	0.927	-43.3	1.93	127	0.006	59.9	0.942	-32.1
700	0.925	-46.5	1.90	123	0.006	60.0	0.939	-34.6
750	0.911	-49.4	1.87	120	0.006	58.3	0.933	-36.7
800	0.901	-52.3	1.84	116	0.006	60.3	0.930	-39.1
850	0.893	-55.9	1.81	112	0.005	62.0	0.925	-41.5
900	0.881	-59.0	1.78	108	0.005	61.2	0.921	-43.8
950	0.876	-61.5	1.75	105	0.005	65.0	0.917	-46.1
1000	0.869	-64.3	1.71	102	0.005	68.8	0.913	-48.4

Unit: mm



# Cautions

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